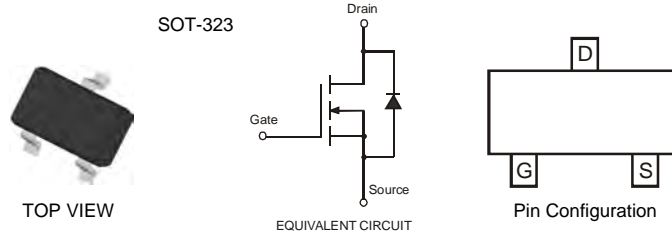


Features

- Low On-Resistance:
 $R_{DS(ON)} < 88m\Omega @ V_{GS} = 4.5V$
 $R_{DS(ON)} < 138m\Omega @ V_{GS} = 2.5V$
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Lead Free By Design/RoHS Compliant (Note 2)**
- "Green" Device (Note 3)**
- Qualified to AEC-Q101 Standards for High Reliability**

Mechanical Data

- Case: SOT-323
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Finish - Matte Tin annealed over Alloy 42 leadframe. Solderable per MIL-STD-202, Method 208
- Terminal Connections: See Diagram
- Marking Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.006 grams (approximate)



Maximum Ratings @ $T_A = 25^\circ C$ unless otherwise specified

| Characteristic | Symbol | Value | Unit |
|--|-----------|--|------|
| Drain-Source Voltage | V_{DSS} | 28 | V |
| Gate-Source Voltage | V_{GSS} | ± 12 | V |
| Drain Current (Note 1) | I_D | 1.6 1.2 | A |
| | | $T_A = 25^\circ C$ $T_A = 70^\circ C$ | |
| Drain Current (Note 1) | I_{DM} | 6.4 | A |
| | | Pulsed | |
| Body-Diode Continuous Current (Note 1) | I_S | 1.5 | A |

Thermal Characteristics

| Characteristic | Symbol | Value | Unit |
|---|-----------------|-------------|--------------|
| Total Power Dissipation (Note 1) | P_D | 350 | mW |
| Thermal Resistance, Junction to Ambient @ $T_A = 25^\circ C$ (Note 1) | $R_{\theta JA}$ | 357 | $^\circ C/W$ |
| Operating and Storage Temperature Range | T_J, T_{STG} | -55 to +150 | $^\circ C$ |

Electrical Characteristics @ $T_A = 25^\circ C$ unless otherwise specified

| Characteristic | Symbol | Min | Typ | Max | Unit | Test Condition |
|-------------------------------------|--------------|------|-----------|-----------------------|-----------|--|
| OFF CHARACTERISTICS (Note 4) | | | | | | |
| Drain-Source Breakdown Voltage | BV_{DSS} | 28 | — | — | V | $V_{GS} = 0V, I_D = 250\mu A$ |
| Zero Gate Voltage Drain Current | I_{DSS} | — | — | 800 | nA | $V_{DS} = 28V, V_{GS} = 0V$ |
| Gate-Body Leakage | I_{GSS} | — | — | ± 80 ± 800 | nA | $V_{GS} = \pm 12V, V_{DS} = 0V$ $V_{GS} = \pm 19V, V_{DS} = 0V$ |
| ON CHARACTERISTICS (Note 4) | | | | | | |
| Gate Threshold Voltage | $V_{GS(th)}$ | 0.62 | 0.94 | 1.4 | V | $V_{DS} = V_{GS}, I_D = 250\mu A$ |
| Static Drain-Source On-Resistance | $R_{DS(ON)}$ | — | 73 115 | 88 138 | $m\Omega$ | $V_{GS} = 4.5V, I_D = 1.6A$ $V_{GS} = 2.5V, I_D = 1.2A$ |
| Forward Transconductance | $ Y_{fs} $ | — | 5.4 | — | S | $V_{DS} = 5V, I_D = 2.7A$ |
| Source-Drain Diode Forward Voltage | V_{SD} | — | — | 1.16 | V | $V_{GS} = 0V, I_S = 1.5A$ |
| DYNAMIC CHARACTERISTICS | | | | | | |
| Input Capacitance | C_{iss} | — | 305 | — | pF | $V_{DS} = 5V, V_{GS} = 0V$ $f = 1.0MHz$ |
| Output Capacitance | C_{oss} | — | 74 | — | pF | |
| Reverse Transfer Capacitance | C_{rss} | — | 48 | — | pF | |

- Notes:
- Device mounted on 1in² FR-4 PCB on 2oz. Copper. $t \leq 10$ sec.
 - No purposefully added lead.
 - Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.
 - Short duration pulse test used to minimize self-heating effect.

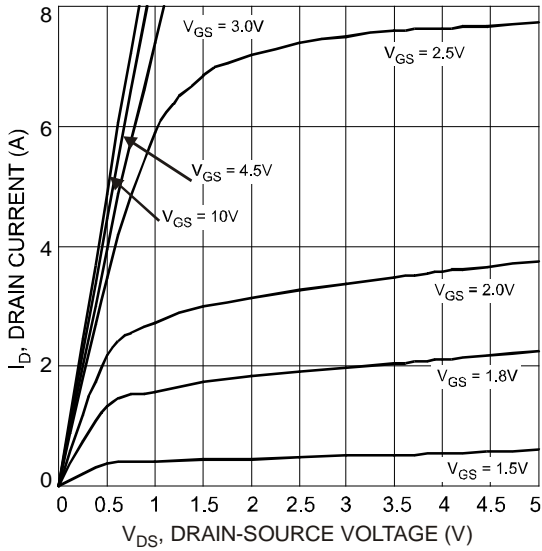


Fig. 1 Typical Output Characteristics

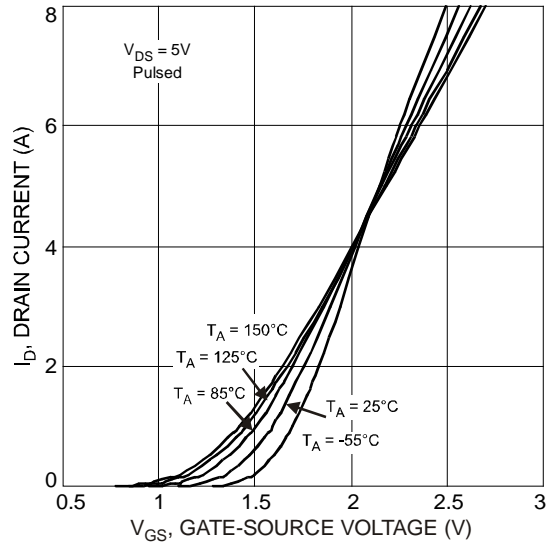


Fig. 2 Typical Transfer Characteristics

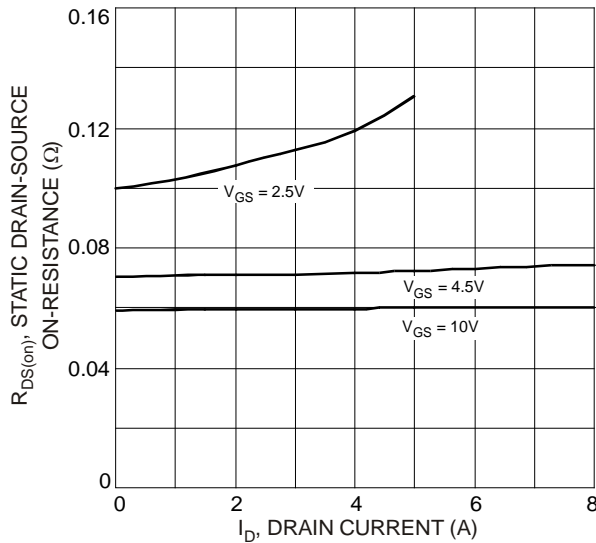


Fig. 3 On-Resistance vs. Drain Current and Gate Voltage

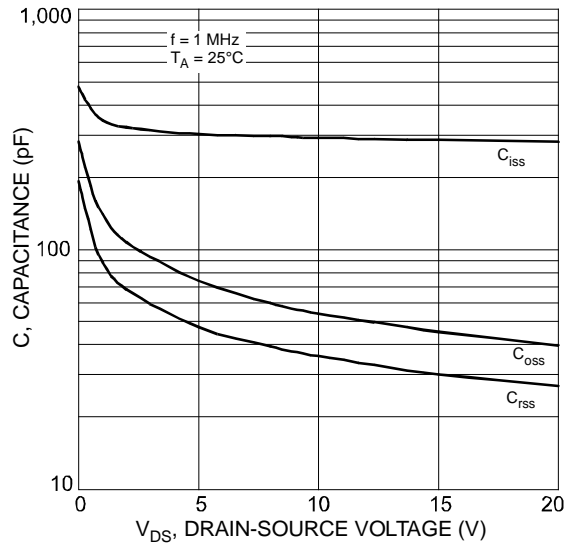


Fig. 4 Typical Total Capacitance

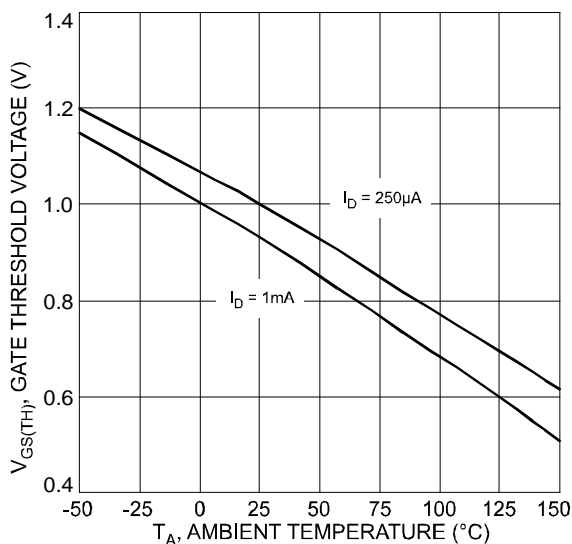


Fig. 5 Gate Threshold Voltage vs. Ambient Temperature

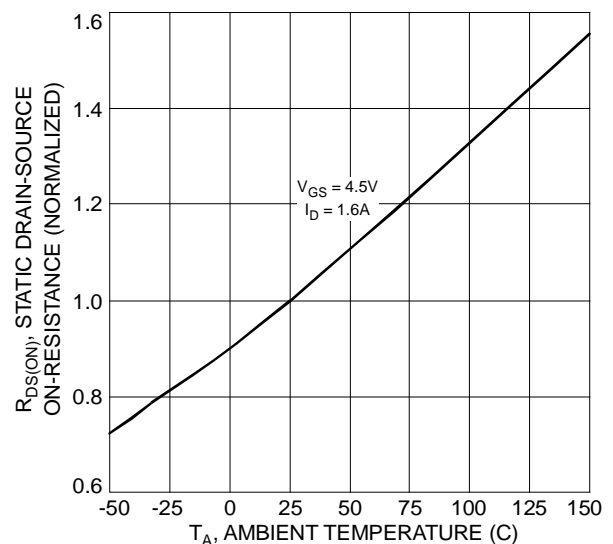


Fig. 6 Normalized Static Drain-Source On-Resistance vs. Ambient Temperature

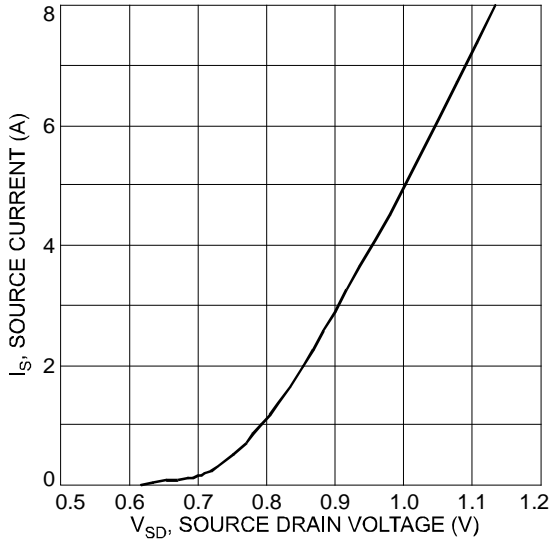


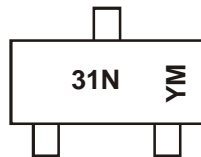
Fig. 7 Reverse Drain Current vs. Source-Drain Voltage

Ordering Information (Note 5)

| Part Number | Case | Packaging |
|-------------|---------|------------------|
| DMN3150LW-7 | SOT-323 | 3000/Tape & Reel |

Notes: 5. For packaging details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

Marking Information



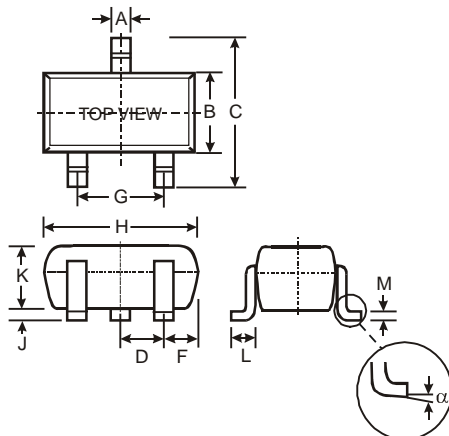
31N = Product Type Marking Code
 YM = Date Code Marking
 Y = Year (ex: V = 2008)
 M = Month (ex: 9 = September)

Date Code Key

| Year | 2008 | 2009 | 2010 | 2011 | 2012 | 2013 | 2014 | 2015 |
|------|------|------|------|------|------|------|------|------|
| Code | V | W | X | Y | Z | A | B | C |

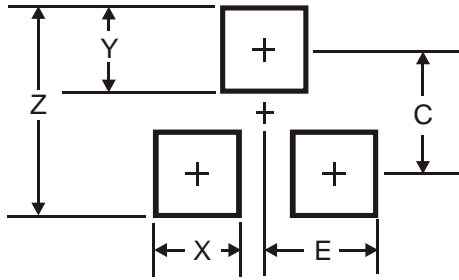
| Month | Jan | Feb | Mar | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |
|-------|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| Code | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | O | N | D |

Package Outline Dimensions



| SOT-323 | | | |
|----------------------|------|------|-------|
| Dim | Min | Max | Typ |
| A | 0.25 | 0.40 | 0.30 |
| B | 1.15 | 1.35 | 1.30 |
| C | 2.00 | 2.20 | 2.10 |
| D | - | - | 0.65 |
| F | 0.30 | 0.40 | 0.425 |
| G | 1.20 | 1.40 | 1.30 |
| H | 1.80 | 2.20 | 2.15 |
| J | 0.0 | 0.10 | 0.05 |
| K | 0.90 | 1.00 | 1.00 |
| L | 0.25 | 0.40 | 0.30 |
| M | 0.10 | 0.18 | 0.11 |
| α | 0° | 8° | - |
| All Dimensions in mm | | | |

Suggested Pad Layout



| Dimensions | Value (in mm) |
|------------|---------------|
| Z | 2.8 |
| X | 0.7 |
| Y | 0.9 |
| C | 1.9 |
| E | 1.0 |

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- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
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- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



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